



HIGH RIPPLE-REJECTION AND LOW DROPOUT CMOS VOLTAGE REGULATOR

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Rev.6.0_00

The S-1112/1122 Series is a positive voltage regulator with a low dropout voltage, high output voltage accuracy, and low current consumption developed based on CMOS technology.

A built-in low on-resistance transistor provides a low dropout voltage and large output current, and a built-in overcurrent protector prevents the load current from exceeding the current capacitance of the output transistor. An ON/OFF circuit ensures a long battery life. Compared with the voltage regulators using the conventional CMOS process, a larger variety of capacitors are available, including small ceramic capacitors. Small SNT-6A(H) (S-1112 Series only) and SOT-23-5 packages realize high-density mounting. In SOT-23-5, the lineup includes the S-1112 and S-1122 Series, which differ in pin configuration.

■ Features

- Output voltage: 1.5 V to 5.5 V, selectable in 0.1 V steps.
- High-accuracy output voltage: $\pm 1.0\%$
- Low dropout voltage: 190 mV typ. (3.0 V output product, $I_{OUT} = 100$ mA)
- Low current consumption: During operation: 50 μ A typ., 90 μ A max.
During shutdown: 0.1 μ A typ., 1.0 μ A max.
- High peak current capability: 150 mA output is possible (at $V_{IN} \geq V_{OUT(S)} + 1.0$ V)^{*1}
- Built-in ON/OFF circuit: Ensures long battery life.
- Low ESR capacitor can be used: A ceramic capacitor of 0.47 μ F or more can be used for the output capacitor.
- High ripple rejection: 80 dB typ. (at 1.0 kHz)
- Built-in overcurrent protector: Overcurrent of output transistor can be restricted.
- Lead-free, Sn 100%, halogen-free^{*2}

*1. Attention should be paid to the power dissipation of the package when the output current is large.

*2. Refer to “**■ Product Name Structure**” for details.

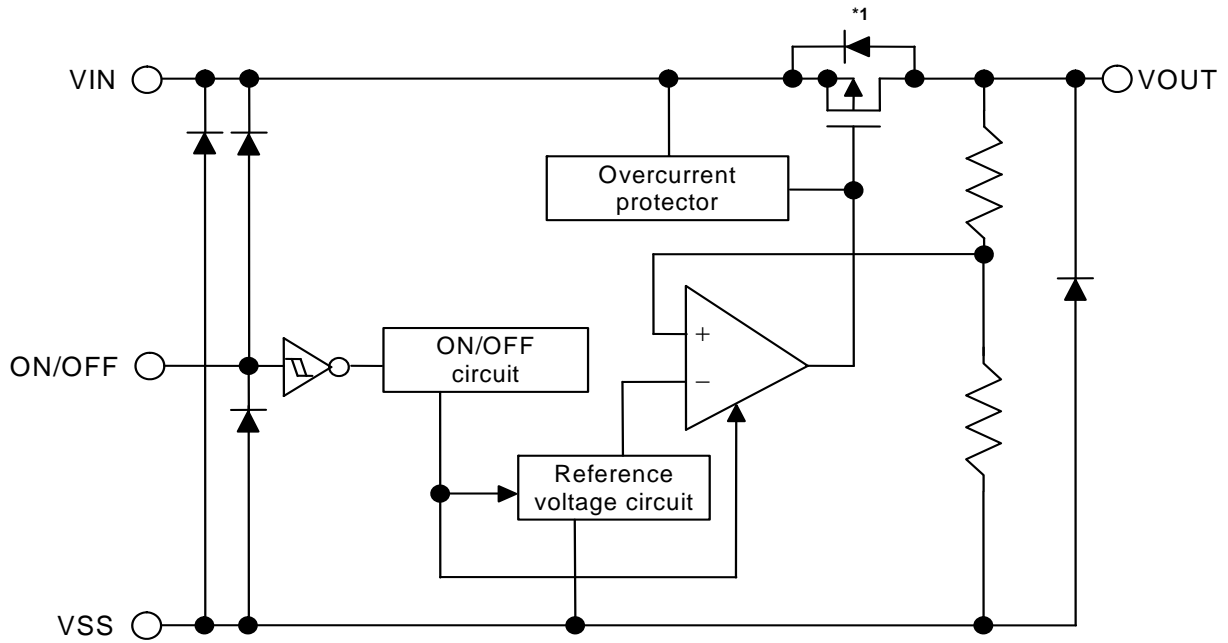
■ Applications

- Power supply for battery-powered devices
- Power supply for personal communication devices
- Power supply for home electric/electronic appliances
- Power supply for cellular phones

■ Packages

- SNT-6A(H)
- SOT-23-5

■ **Block Diagram**



*1. Parasitic diode

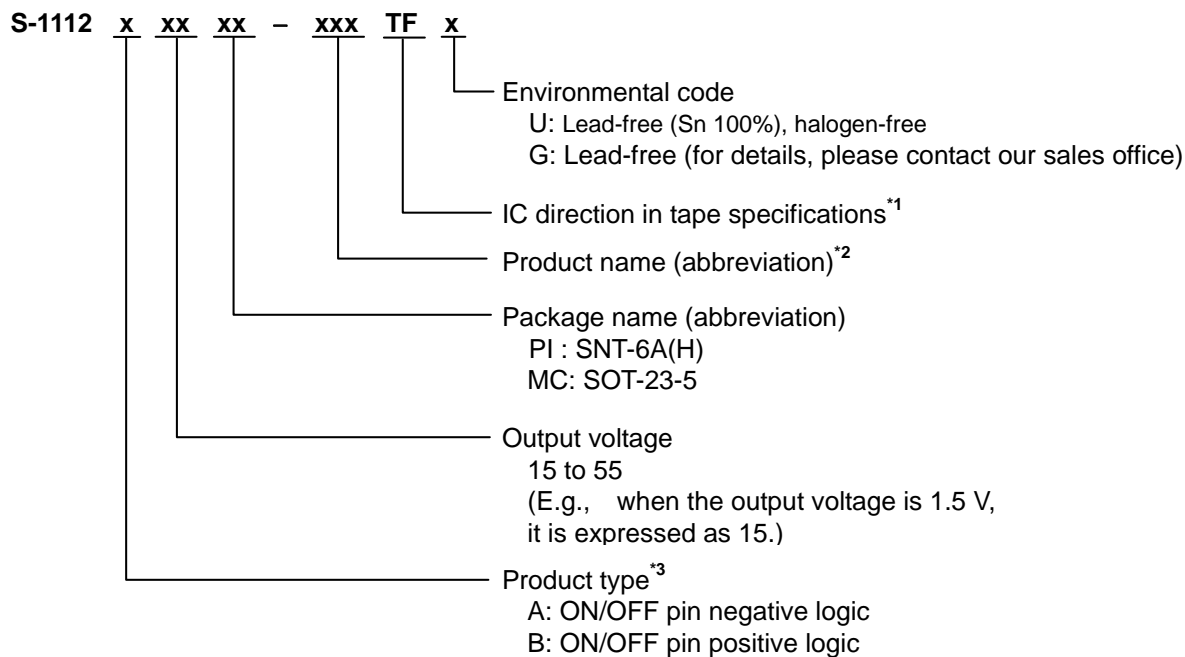
Figure 1

■ **Product Name Structure**

The product types and output voltage for the S-1112/1122 Series can be selected at the user's request. Refer to the "1. **Product Name**" for the construction of the product name, "2. **Package**" regarding the package drawings and "3. **Product Name List**" for the full product names.

1. **Product name**

(1) **S-1112 Series**

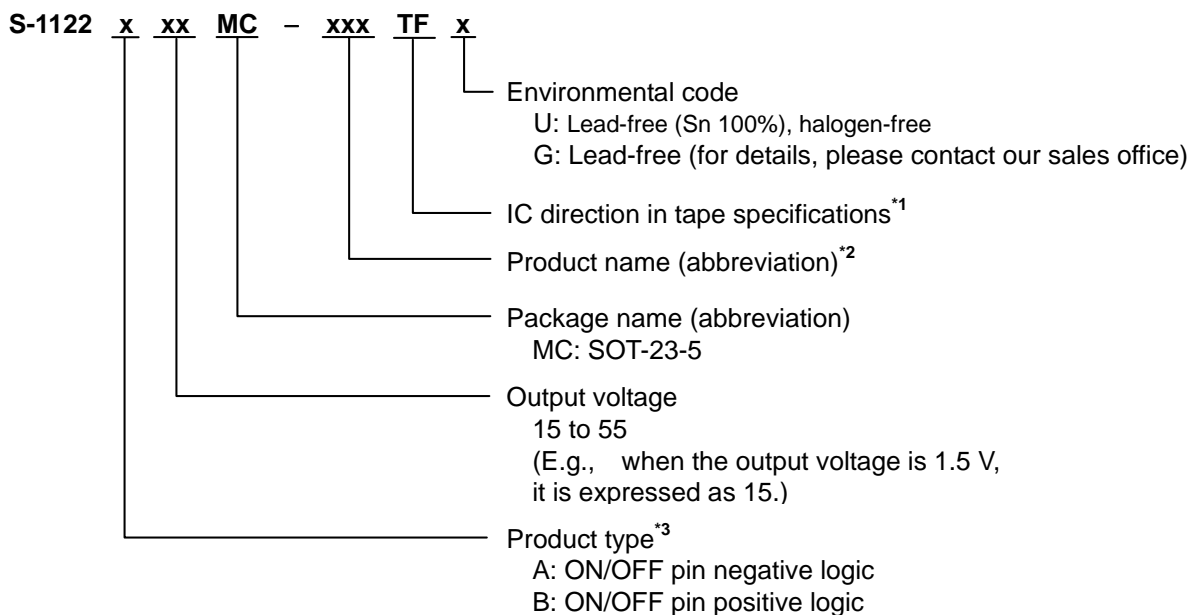


*1. Refer to the tape specifications at the end of this book.

*2. Refer to the product name list.

*3. Refer to 3. **Shutdown pin (ON/OFF pin)** in the "■ **Operation**".

(2) S-1122 Series



*1. Refer to the tape specifications at the end of this book.

*2. Refer to the product name list.

*3. Refer to 3. Shutdown pin (ON/OFF pin) in the "■ Operation".

2. Package

Package name	Drawing code			
	Package	Tape	Reel	Land
SNT-6A(H)	PI006-A-P-SD	PI006-A-C-SD	PI006-A-R-SD	PI006-A-L-SD
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD	—

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Rev.6.0_00

S-1112/1122 Series

3. Product name list

(1) S-1112 Series

Table 1

Output Voltage	SNT-6A(H)	SOT-23-5
1.5 V \pm 1.0%	S-1112B15PI-L6ATF _x	S-1112B15MC-L6ATF _x
1.6 V \pm 1.0%	S-1112B16PI-L6BTF _x	S-1112B16MC-L6BTF _x
1.7 V \pm 1.0%	S-1112B17PI-L6CTF _x	S-1112B17MC-L6CTF _x
1.8 V \pm 1.0%	S-1112B18PI-L6DTF _x	S-1112B18MC-L6DTF _x
1.9 V \pm 1.0%	S-1112B19PI-L6ETF _x	S-1112B19MC-L6ETF _x
2.0 V \pm 1.0%	S-1112B20PI-L6FTF _x	S-1112B20MC-L6FTF _x
2.1 V \pm 1.0%	S-1112B21PI-L6GTF _x	S-1112B21MC-L6GTF _x
2.2 V \pm 1.0%	S-1112B22PI-L6HTF _x	S-1112B22MC-L6HTF _x
2.3 V \pm 1.0%	S-1112B23PI-L6ITF _x	S-1112B23MC-L6ITF _x
2.4 V \pm 1.0%	S-1112B24PI-L6JTF _x	S-1112B24MC-L6JTF _x
2.5 V \pm 1.0%	S-1112B25PI-L6KTF _x	S-1112B25MC-L6KTF _x
2.6 V \pm 1.0%	S-1112B26PI-L6LTF _x	S-1112B26MC-L6LTF _x
2.7 V \pm 1.0%	S-1112B27PI-L6MTF _x	S-1112B27MC-L6MTF _x
2.8 V \pm 1.0%	S-1112B28PI-L6NTF _x	S-1112B28MC-L6NTF _x
2.85 V \pm 1.0%	S-1112B2JPI-L7PTF _x	S-1112B2JMC-L7PTF _x
2.9 V \pm 1.0%	S-1112B29PI-L6OTF _x	S-1112B29MC-L6OTF _x
3.0 V \pm 1.0%	S-1112B30PI-L6PTF _x	S-1112B30MC-L6PTF _x
3.1 V \pm 1.0%	S-1112B31PI-L6QTF _x	S-1112B31MC-L6QTF _x
3.2 V \pm 1.0%	S-1112B32PI-L6RTF _x	S-1112B32MC-L6RTF _x
3.3 V \pm 1.0%	S-1112B33PI-L6STF _x	S-1112B33MC-L6STF _x
3.4 V \pm 1.0%	S-1112B34PI-L6TTF _x	S-1112B34MC-L6TTF _x
3.5 V \pm 1.0%	S-1112B35PI-L6UTF _x	S-1112B35MC-L6UTF _x
3.6 V \pm 1.0%	S-1112B36PI-L6VTF _x	S-1112B36MC-L6VTF _x
3.7 V \pm 1.0%	S-1112B37PI-L6WTF _x	S-1112B37MC-L6WTF _x
3.8 V \pm 1.0%	S-1112B38PI-L6XTF _x	S-1112B38MC-L6XTF _x
3.9 V \pm 1.0%	S-1112B39PI-L6YTF _x	S-1112B39MC-L6YTF _x
4.0 V \pm 1.0%	S-1112B40PI-L6ZTF _x	S-1112B40MC-L6ZTF _x
4.1 V \pm 1.0%	S-1112B41PI-L7ATF _x	S-1112B41MC-L7ATF _x
4.2 V \pm 1.0%	S-1112B42PI-L7BTF _x	S-1112B42MC-L7BTF _x
4.3 V \pm 1.0%	S-1112B43PI-L7CTF _x	S-1112B43MC-L7CTF _x
4.4 V \pm 1.0%	S-1112B44PI-L7DTF _x	S-1112B44MC-L7DTF _x
4.5 V \pm 1.0%	S-1112B45PI-L7ETF _x	S-1112B45MC-L7ETF _x
4.6 V \pm 1.0%	S-1112B46PI-L7FTF _x	S-1112B46MC-L7FTF _x
4.7 V \pm 1.0%	S-1112B47PI-L7GTF _x	S-1112B47MC-L7GTF _x
4.8 V \pm 1.0%	S-1112B48PI-L7HTF _x	S-1112B48MC-L7HTF _x
4.9 V \pm 1.0%	S-1112B49PI-L7ITF _x	S-1112B49MC-L7ITF _x
5.0 V \pm 1.0%	S-1112B50PI-L7JTF _x	S-1112B50MC-L7JTF _x
5.1 V \pm 1.0%	S-1112B51PI-L7KTF _x	S-1112B51MC-L7KTF _x
5.2 V \pm 1.0%	S-1112B52PI-L7LTF _x	S-1112B52MC-L7LTF _x
5.3 V \pm 1.0%	S-1112B53PI-L7MTF _x	S-1112B53MC-L7MTF _x
5.4 V \pm 1.0%	S-1112B54PI-L7NTF _x	S-1112B54MC-L7NTF _x
5.5 V \pm 1.0%	S-1112B55PI-L7OTF _x	S-1112B55MC-L7OTF _x

Remark 1. Please contact our sales office for type A products.

2. x: G or U

3. Please select products of environmental code = U for Sn 100%, halogen-free products.

(2) S-1122 Series

Table 2

Output Voltage	SOT-23-5
1.5 V ±1.0%	S-1122B15MC-L8ATF _x
1.6 V ±1.0%	S-1122B16MC-L8BTF _x
1.7 V ±1.0%	S-1122B17MC-L8CTF _x
1.8 V ±1.0%	S-1122B18MC-L8DTF _x
1.9 V ±1.0%	S-1122B19MC-L8ETF _x
2.0 V ±1.0%	S-1122B20MC-L8FTF _x
2.1 V ±1.0%	S-1122B21MC-L8GTF _x
2.2 V ±1.0%	S-1122B22MC-L8HTF _x
2.3 V ±1.0%	S-1122B23MC-L8ITF _x
2.4 V ±1.0%	S-1122B24MC-L8JTF _x
2.5 V ±1.0%	S-1122B25MC-L8KTF _x
2.6 V ±1.0%	S-1122B26MC-L8LTF _x
2.7 V ±1.0%	S-1122B27MC-L8MTF _x
2.8 V ±1.0%	S-1122B28MC-L8NTF _x
2.9 V ±1.0%	S-1122B29MC-L8OTF _x
3.0 V ±1.0%	S-1122B30MC-L8PTF _x
3.1 V ±1.0%	S-1122B31MC-L8QTF _x
3.2 V ±1.0%	S-1122B32MC-L8RTF _x
3.3 V ±1.0%	S-1122B33MC-L8STF _x
3.4 V ±1.0%	S-1122B34MC-L8TTF _x
3.5 V ±1.0%	S-1122B35MC-L8UTF _x
3.6 V ±1.0%	S-1122B36MC-L8VTF _x
3.7 V ±1.0%	S-1122B37MC-L8WTF _x
3.8 V ±1.0%	S-1122B38MC-L8XTF _x
3.9 V ±1.0%	S-1122B39MC-L8YTF _x
4.0 V ±1.0%	S-1122B40MC-L8ZTF _x
4.1 V ±1.0%	S-1122B41MC-L9ATF _x
4.2 V ±1.0%	S-1122B42MC-L9BTF _x
4.3 V ±1.0%	S-1122B43MC-L9CTF _x
4.4 V ±1.0%	S-1122B44MC-L9DTF _x
4.5 V ±1.0%	S-1122B45MC-L9ETF _x
4.6 V ±1.0%	S-1122B46MC-L9FTF _x
4.7 V ±1.0%	S-1122B47MC-L9GTF _x
4.8 V ±1.0%	S-1122B48MC-L9HTF _x
4.9 V ±1.0%	S-1122B49MC-L9ITF _x
5.0 V ±1.0%	S-1122B50MC-L9JTF _x
5.1 V ±1.0%	S-1122B51MC-L9KTF _x
5.2 V ±1.0%	S-1122B52MC-L9LTF _x
5.3 V ±1.0%	S-1122B53MC-L9MTF _x
5.4 V ±1.0%	S-1122B54MC-L9NTF _x
5.5 V ±1.0%	S-1122B55MC-L9OTF _x

Remark 1. Please contact our sales office for type A products.

2. x: G or U

3. Please select products of environmental code = U for Sn 100%, halogen-free products.

■ Pin Configuration

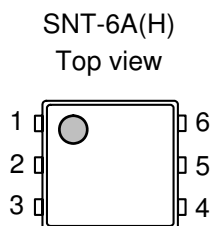


Figure 2

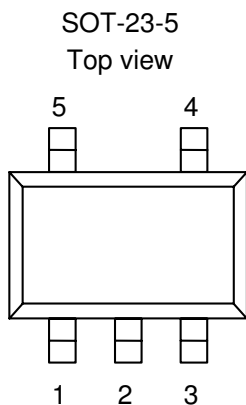


Figure 3

Table 3

(S-1112 Series)

Pin No.	Symbol	Description
1	NC ^{*1}	No connection
2	VSS	GND pin
3	ON/OFF	Shutdown pin
4	VIN	Input voltage pin
5	VSS	GND pin
6	VOUT	Output voltage pin

*1. The NC pin is electrically open.
The NC pin can be connected to VIN or VSS.

Table 4

(S-1112 Series)

Pin No.	Symbol	Description
1	VIN	Input voltage pin
2	VSS	GND pin
3	ON/OFF	Shutdown pin
4	NC ^{*1}	No connection
5	VOUT	Output voltage pin

*1. The NC pin is electrically open.
The NC pin can be connected to VIN or VSS.

Table 5

(S-1122 Series)

Pin No.	Symbol	Description
1	VOUT	Output voltage pin
2	VSS	GND pin
3	VIN	Input voltage pin
4	ON/OFF	Shutdown pin
5	NC ^{*1}	No connection

*1. The NC pin is electrically open.
The NC pin can be connected to VIN or VSS.

■ **Absolute Maximum Ratings**

Table 6

(Ta = 25°C unless otherwise specified)

Item		Symbol	Absolute Maximum Rating	Unit
Input voltage		V _{IN}	V _{SS} - 0.3 to V _{SS} + 7	V
		V _{ON/OFF}	V _{SS} - 0.3 to V _{IN} + 0.3	V
Output voltage		V _{OUT}	V _{SS} - 0.3 to V _{IN} + 0.3	V
Power dissipation	SNT-6A(H)	P _D	500 ^{*1}	mW
	SOT-23-5		300 (When not mounted on board)	mW
			600 ^{*1}	mW
Operating ambient temperature		T _{opr}	-40 to +85	°C
Storage temperature		T _{stg}	-40 to +125	°C

*1. When mounted on board
 [Mounted board]

- (1) Board size : 114.3 mm × 76.2 mm × t1.6 mm
- (2) Board name : JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

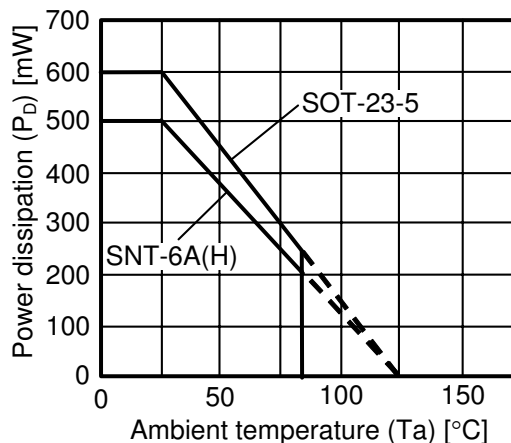


Figure 4 Power Dissipation of The Package (When Mounted on Board)

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S-1112/1122 Series

■ Electrical Characteristics

Table 7

(Ta = 25°C unless otherwise specified)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit	Test Circuit	
Output voltage*1	V _{OUT(E)}	V _{IN} = V _{OUT(S)} + 1.0 V, I _{OUT} = 30 mA	V _{OUT(S)} × 0.99	V _{OUT(S)}	V _{OUT(S)} × 1.01	V	1	
Output current*2	I _{OUT}	V _{IN} ≥ V _{OUT(S)} + 1.0 V	150*5	—	—	mA	3	
Dropout voltage*3	V _{drop}	I _{OUT} = 100 mA	1.5 V ≤ V _{OUT(S)} ≤ 1.6 V	—	0.32	0.55	V	1
			1.7 V ≤ V _{OUT(S)} ≤ 1.8 V	—	0.28	0.47	V	1
			1.9 V ≤ V _{OUT(S)} ≤ 2.3 V	—	0.25	0.35	V	1
			2.4 V ≤ V _{OUT(S)} ≤ 2.7 V	—	0.20	0.29	V	1
			2.8 V ≤ V _{OUT(S)} ≤ 5.5 V	—	0.19	0.26	V	1
Line regulation	$\frac{\Delta V_{OUT1}}{\Delta V_{IN} \cdot V_{OUT}}$	V _{OUT(S)} + 0.5 V ≤ V _{IN} ≤ 6.5 V, I _{OUT} = 30 mA	—	0.05	0.2	% / V	1	
Load regulation	ΔV _{OUT2}	V _{IN} = V _{OUT(S)} + 1.0 V, 1.0 mA ≤ I _{OUT} ≤ 80 mA	—	12	40	mV	1	
Output voltage temperature coefficient*4	$\frac{\Delta V_{OUT}}{\Delta T_a \cdot V_{OUT}}$	V _{IN} = V _{OUT(S)} + 1.0 V, I _{OUT} = 10 mA, -40°C ≤ Ta ≤ 85°C	—	±100	—	ppm/ °C	1	
Current consumption during operation	I _{SS1}	V _{IN} = V _{OUT(S)} + 1.0 V, ON/OFF pin = ON, no load	—	50	90	μA	2	
Current consumption during shutdown	I _{SS2}	V _{IN} = V _{OUT(S)} + 1.0 V, ON/OFF pin = OFF, no load	—	0.1	1.0	μA	2	
Input voltage	V _{IN}	—	2.0	—	6.5	V	—	
Shutdown pin input voltage "H"	V _{SH}	V _{IN} = V _{OUT(S)} + 1.0 V, R _L = 1.0 kΩ	1.5	—	—	V	4	
Shutdown pin input voltage "L"	V _{SL}	V _{IN} = V _{OUT(S)} + 1.0 V, R _L = 1.0 kΩ	—	—	0.3	V	4	
Shutdown pin input current "H"	I _{SH}	V _{IN} = 6.5 V, V _{ON/OFF} = 6.5 V	-0.1	—	0.1	μA	4	
Shutdown pin input current "L"	I _{SL}	V _{IN} = 6.5 V, V _{ON/OFF} = 0 V	-0.1	—	0.1	μA	4	
Ripple rejection	RR	V _{IN} = V _{OUT(S)} + 1.0 V, f = 1.0 kHz, ΔV _{rip} = 0.5 V _{rms} , I _{OUT} = 30 mA	—	80	—	dB	5	
Short-circuit current	I _{short}	V _{IN} = V _{OUT(S)} + 1.0 V, ON/OFF pin = ON, V _{OUT} = 0 V	—	200	—	mA	3	

*1. V_{OUT(S)}: Specified output voltage

V_{OUT(E)}: Actual output voltage at the fixed load

The output voltage when fixing I_{OUT}(= 30 mA) and inputting V_{OUT(S)} + 1.0 V

*2. The output current at which the output voltage becomes 95% of V_{OUT(E)} after gradually increasing the output current.

*3. V_{drop} = V_{IN1} - (V_{OUT3} × 0.98)

V_{OUT3} is the output voltage when V_{IN} = V_{OUT(S)} + 1.0 V and I_{OUT} = 100 mA.

V_{IN1} is the input voltage at which the output voltage becomes 98% of V_{OUT3} after gradually decreasing the input voltage.

*4. The change in temperature [mV/°C] is calculated using the following equation.

$$\frac{\Delta V_{OUT}}{\Delta T_a} [\text{mV}/^\circ\text{C}]^*1 = V_{OUT(S)} [\text{V}]^*2 \times \frac{\Delta V_{OUT}}{\Delta T_a \cdot V_{OUT}} [\text{ppm}/^\circ\text{C}]^*3 \div 1000$$

*1. The change in temperature of the output voltage

*2. Specified output voltage

*3. Output voltage temperature coefficient

*5. The output current can be at least this value.

Due to restrictions on the package power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation of the package when the output current is large.

This specification is guaranteed by design.

■ **Test Circuits**

1.

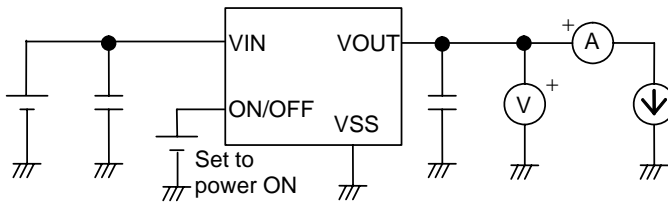


Figure 5

2.

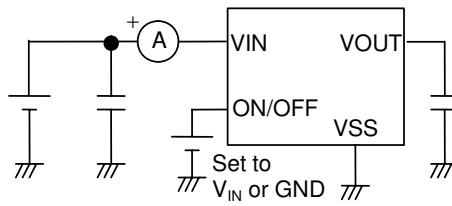


Figure 6

3.

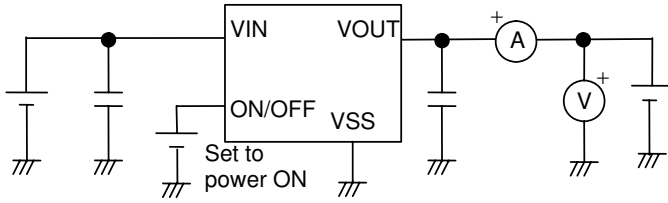


Figure 7

4.

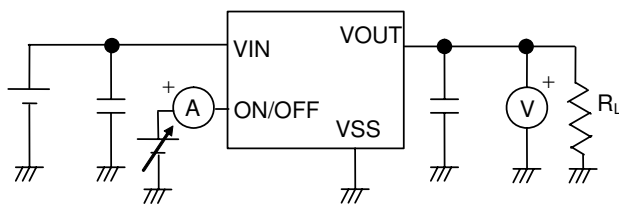


Figure 8

5.

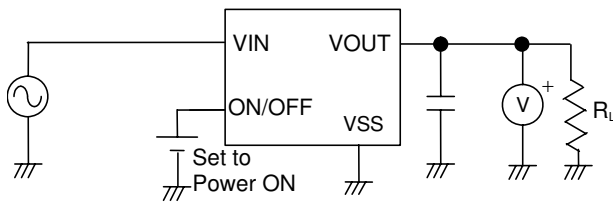
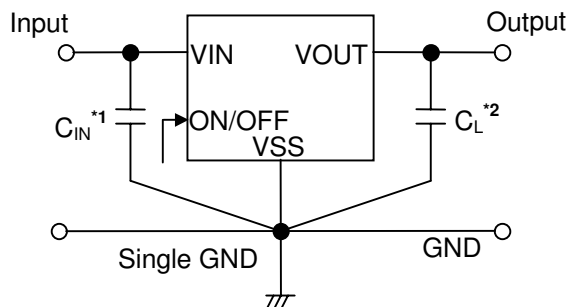


Figure 9

■ Standard Circuit



*1. C_{IN} is a capacitor for stabilizing the input.

*2. A ceramic capacitor of 0.47 μF or more can be used for C_L .

Figure 10

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

■ Application Conditions

Input capacitor (C_{IN}):	1.0 μF or more
Output capacitor (C_L):	0.47 μF or more
ESR of output capacitor:	10 Ω or less

Caution A general series regulator may oscillate, depending on the external components selected. Check that no oscillation occurs with the application using the above capacitor.

■ **Explanation of Terms**

1. Low dropout voltage regulator

The low dropout voltage regulator is a voltage regulator whose dropout voltage is low due to its built-in low on-resistance transistor.

2. Low ESR

A capacitor whose ESR (Equivalent Series Resistance) is low. The S-1112/1122 Series enables use of a low ESR capacitor, such as a ceramic capacitor, for the output-side capacitor C_L . A capacitor whose ESR is 10 Ω or less can be used.

3. Output voltage (V_{OUT})

The accuracy of the output voltage is ensured at $\pm 1.0\%$ under the specified conditions of fixed input voltage^{*1}, fixed output current, and fixed temperature.

*1. Differs depending the product.

Caution If the above conditions change, the output voltage value may vary and exceed the accuracy range of the output voltage. Please see the electrical characteristics and attached characteristics data for details.

4. Line regulation $\left(\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}} \right)$

Indicates the dependency of the output voltage on the input voltage. That is, the values show how much the output voltage changes due to a change in the input voltage with the output current remaining unchanged.

5. Load regulation (ΔV_{OUT2})

Indicates the dependency of the output voltage on the output current. That is, the values show how much the output voltage changes due to a change in the output current with the input voltage remaining unchanged.

6. Dropout voltage (V_{drop})

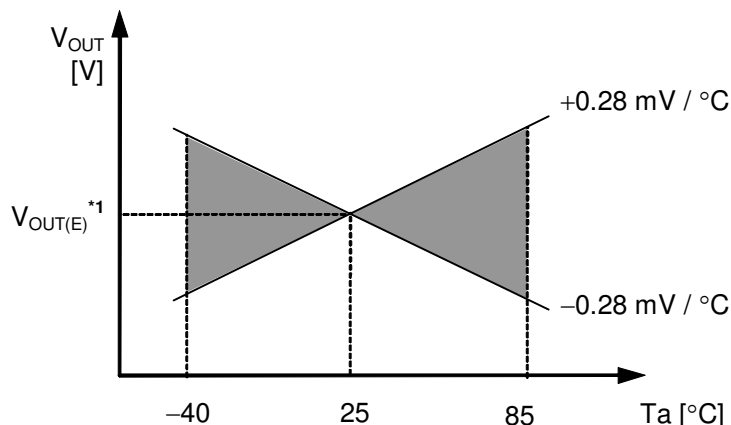
Indicates the difference between the input voltage V_{IN1} , which is the input voltage (V_{IN}) at the point where the output voltage has fallen to 98% of the output voltage value V_{OUT3} after V_{IN} was gradually decreased from $V_{IN} = V_{OUT(S)} + 1.0$ V, and the output voltage at that point ($V_{OUT3} \times 0.98$).

$$V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$$

7. Temperature coefficient of output voltage $\left(\frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} \right)$

The shadowed area in **Figure 11** is the range where V_{OUT} varies in the operating temperature range when the temperature coefficient of the output voltage is ± 100 ppm/ $^{\circ}\text{C}$.

Ex. S-1112/1122B28 Typ.



*1. $V_{OUT(E)}$ is the value of the output voltage measured at 25°C.

Figure 11

A change in the temperature of the output voltage [mV/ $^{\circ}\text{C}$] is calculated using the following equation.

$$\frac{\Delta V_{OUT}}{\Delta T_a} [\text{mV} / ^{\circ}\text{C}]^{*1} = V_{OUT(S)} [\text{V}]^{*2} \times \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} [\text{ppm} / ^{\circ}\text{C}]^{*3} \div 1000$$

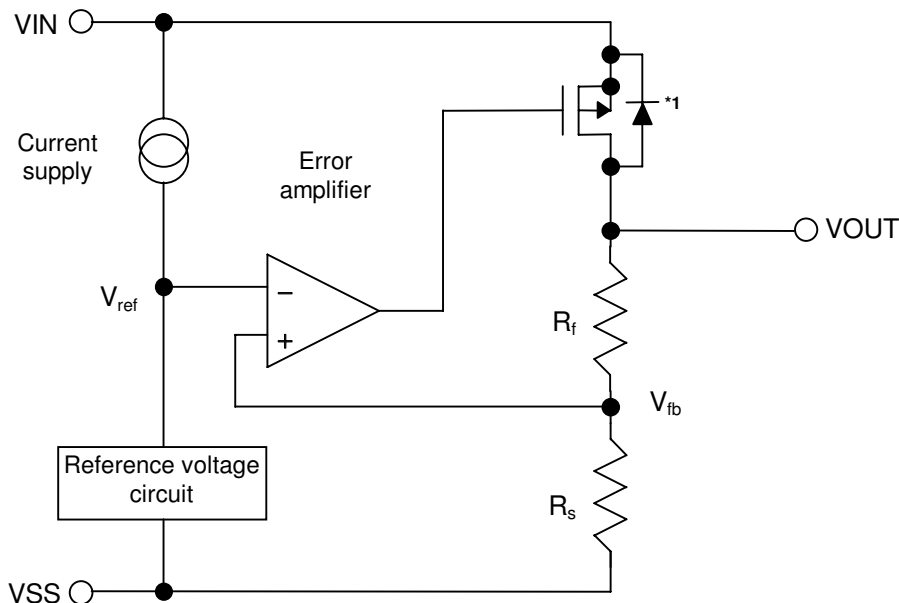
- *1. Change in temperature of output voltage
- *2. Specified output voltage
- *3. Output voltage temperature coefficient

■ **Operation**

1. Basic operation

Figure 12 shows the block diagram of the S-1112/1122 Series.

The error amplifier compares the reference voltage (V_{ref}) with V_{fb} , which is the output voltage resistance-divided by feedback resistors R_s and R_f . It supplies the output transistor with the gate voltage necessary to ensure a certain output voltage free of any fluctuations of input voltage and temperature.



*1. Parasitic diode

Figure 12

2. Output transistor

The S-1112/1122 Series uses a low on-resistance P-channel MOS FET as the output transistor. Be sure that V_{OUT} does not exceed $V_{IN} + 0.3$ V to prevent the voltage regulator from being damaged due to inverse current flowing from VOUT pin through a parasitic diode to VIN pin.

3. Shutdown pin (ON/OFF pin)

This pin starts and stops the regulator.

When the ON/OFF pin is set to the shutdown level, the operation of all internal circuits stops, and the built-in P-channel MOS FET output transistor between the VIN pin and VOUT pin is turned off to substantially reduce the current consumption. The VOUT pin becomes the V_{SS} level due to the internally divided resistance of several MΩ between the VOUT pin and VSS pin.

The structure of the ON/OFF pin is as shown in **Figure 13**. Since the ON/OFF pin is neither pulled down nor pulled up internally, do not use it in the floating state. In addition, note that the current consumption increases if a voltage of 0.3 V to V_{IN} - 0.3 V is applied to the ON/OFF pin. When the ON/OFF pin is not used, connect it to the VSS pin if the logic type is “A” and to the VIN pin if it is “B”.

Table 8

Logic Type	ON/OFF Pin	Internal Circuits	VOUT Pin Voltage	Current Consumption
A	“L”: Power on	Operating	Set value	I _{SS1}
A	“H”: Power off	Stopped	V _{SS} level	I _{SS2}
B	“L”: Power off	Stopped	V _{SS} level	I _{SS2}
B	“H”: Power on	Operating	Set value	I _{SS1}

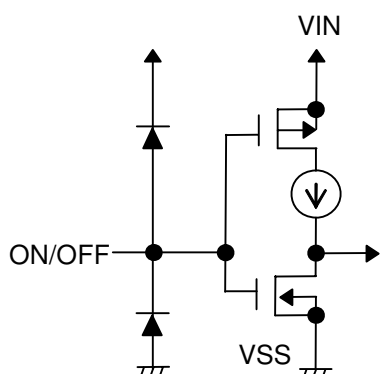


Figure 13

■ Selection of Output Capacitor (C_L)

The S-1112/1122 Series requires an output capacitor between the VOUT and VSS pins for phase compensation. A ceramic capacitor with a capacitance of 0.47 μF or more can be used. Even if using an OS capacitor, tantalum capacitor, or aluminum electrolytic capacitor, a capacitance of 0.47 μF or more and an ESR of 10 Ω or less are required.

The value of the output overshoot or undershoot transient response varies depending on the value of the output capacitor.

When selecting the output capacitor, perform sufficient evaluation, including evaluation of temperature characteristics, on the actual device.

■ **Precautions**

- Wiring patterns for the VIN, VOUT and GND pins should be designed so that the impedance is low. When mounting an output capacitor between the VOUT and VSS pins (C_L) and a capacitor for stabilizing the input between VIN and VSS pins (C_{IN}), the distance from the capacitors to these pins should be as short as possible.
- Note that the output voltage may increase when a series regulator is used at low load current (1.0 mA or less).
- Generally a series regulator may cause oscillation, depending on the selection of external parts. The following conditions are recommended for this IC. However, be sure to perform sufficient evaluation under the actual usage conditions for selection, including evaluation of temperature characteristics.

Input capacitor (C_{IN}):	1.0 μ F or more
Output capacitor (C_L):	0.47 μ F or more
Equivalent series resistance (ESR):	10 Ω or less

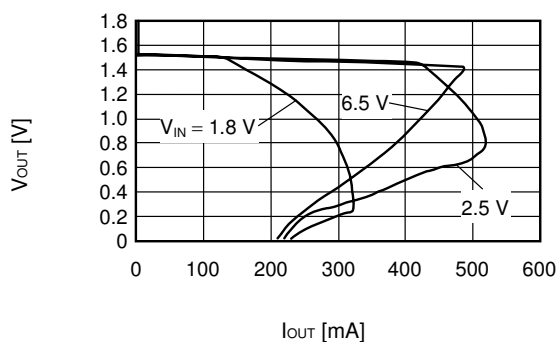
- The voltage regulator may oscillate when the impedance of the power supply is high and the input capacitor is small or an input capacitor is not connected.
- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- In determining the output current, attention should be paid to the output current value specified in **Table 7** in the “■ **Electrical Characteristics**” and footnote *5 of the table.
- SII claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

■ Characteristics (Typical Data)

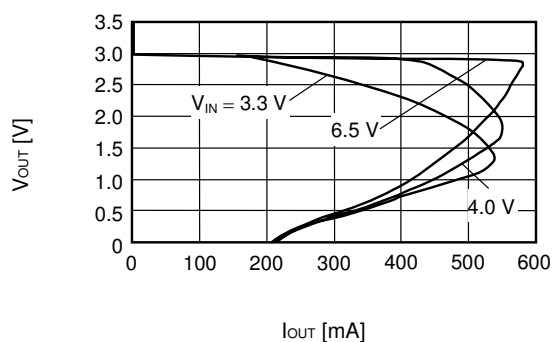
Remark The following, which describes the S-1112 Series as the typical product, shows typical data common to the S-1122 Series.

(1) Output Voltage vs. Output current (when load current increases)

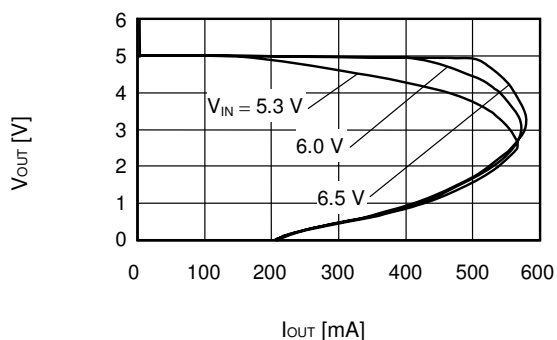
S-1112B15 (Ta = 25°C)



S-1112B30 (Ta = 25°C)



S-1112B50 (Ta = 25°C)

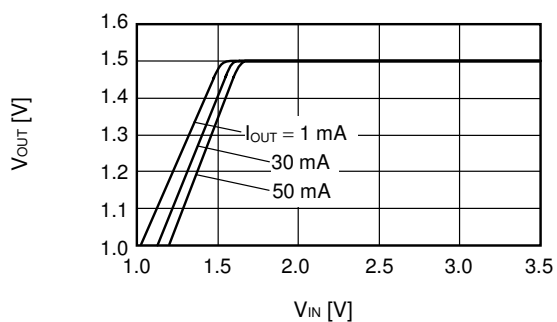


Remark In determining the output current, attention should be paid to the following.

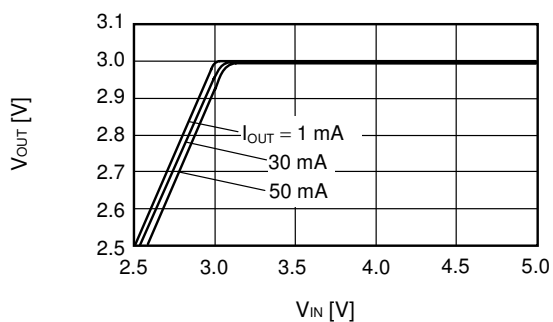
- 1) The minimum output current value and footnote *5 in the “■ Electrical Characteristics”
- 2) The package power dissipation

(2) Output voltage vs. Input voltage

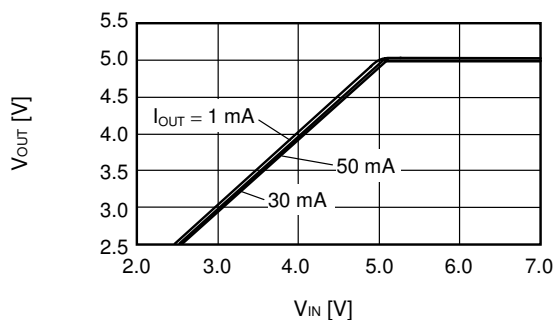
S-1112B15 (Ta = 25°C)



S-1112B30 (Ta = 25°C)

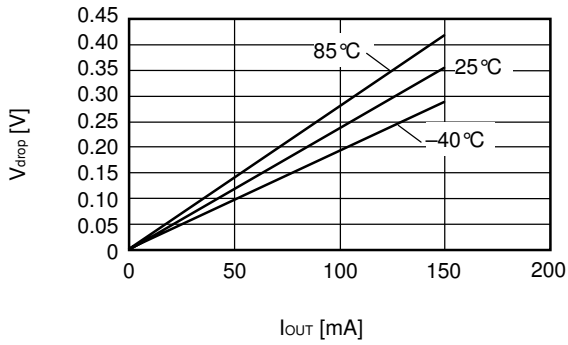


S-1112B50 (Ta = 25°C)

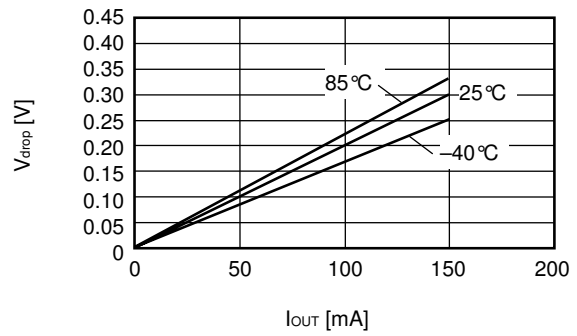


(3) Dropout voltage vs. Output current

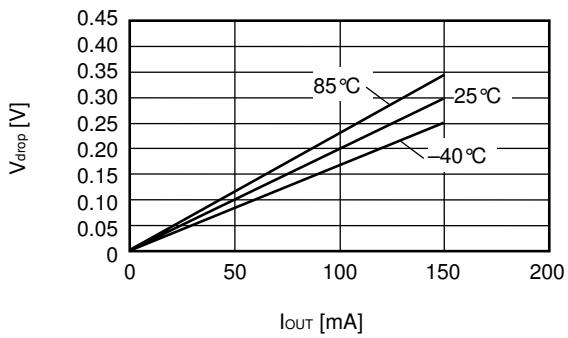
S-1112B15



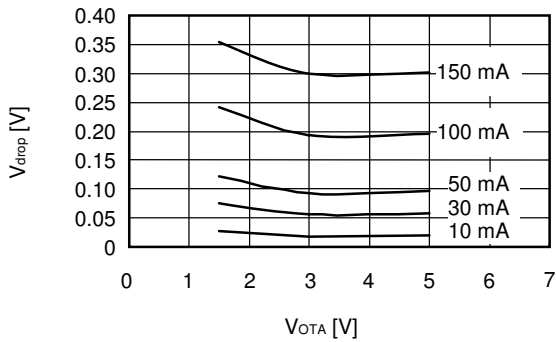
S-1112B30



S-1112B50



(4) Dropout voltage vs. Set output voltage



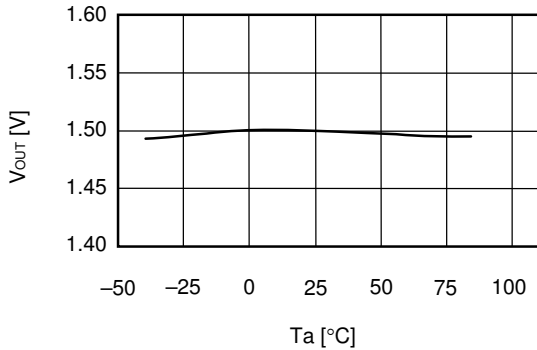
HIGH RIPPLE-REJECTION AND LOW DROPOUT CMOS VOLTAGE REGULATOR

Rev.6.0_00

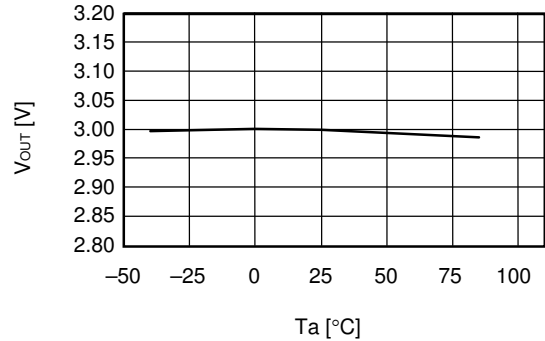
S-1112/1122 Series

(5) Output voltage vs. Ambient temperature

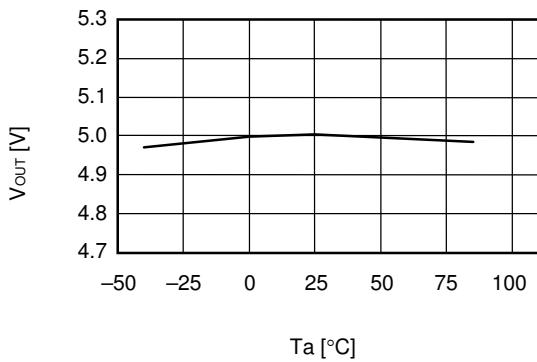
S-1112B15



S-1112B30

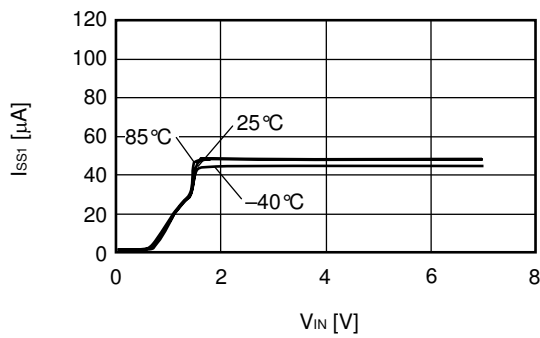


S-1112B50

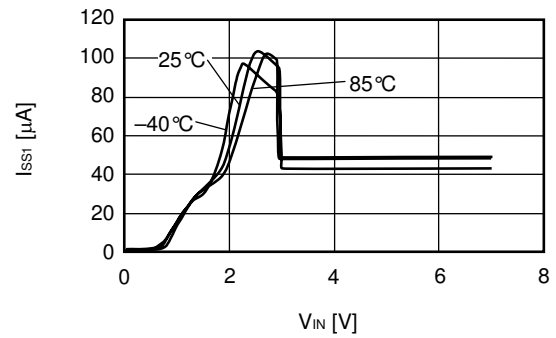


(6) Current consumption vs. Input voltage

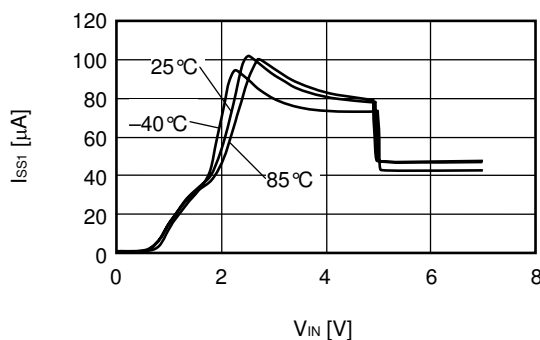
S-1112B15



S-1112B30



S-1112B50



HIGH RIPPLE-REJECTION AND LOW DROPOUT CMOS VOLTAGE REGULATOR

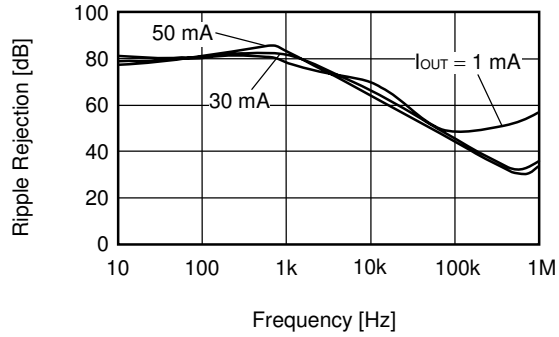
S-1112/1122 Series

Rev.6.0_00

(7) Ripple rejection

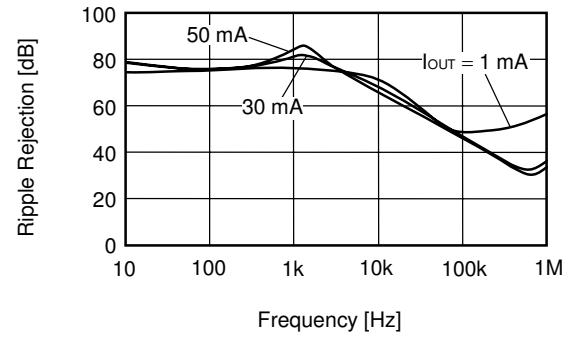
S-1112B15 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 2.5\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$



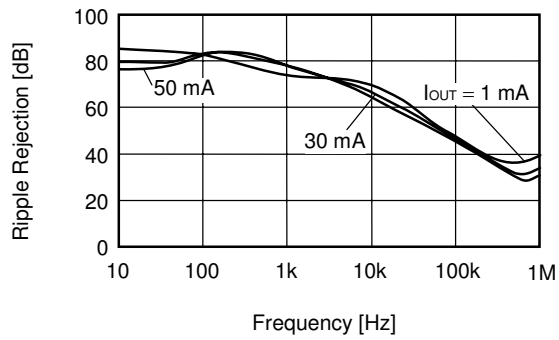
S-1112B30 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 4.0\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$



S-1112B50 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 6.0\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$



HIGH RIPPLE-REJECTION AND LOW DROPOUT CMOS VOLTAGE REGULATOR

Rev.6.0_00

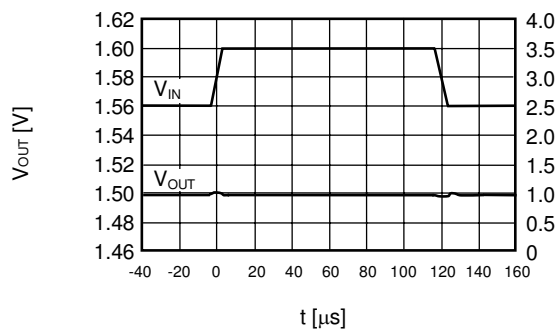
S-1112/1122 Series

Reference Data

(1) Input transient response characteristics

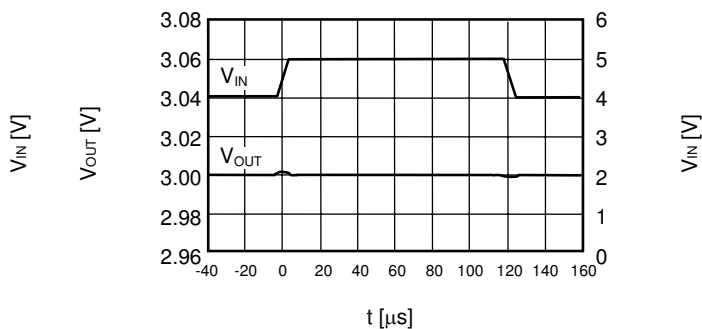
S-1112B15 ($T_a = 25^\circ\text{C}$)

$I_{OUT} = 30\text{ mA}$, $t_r = t_f = 5.0\ \mu\text{s}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 0\ \mu\text{F}$



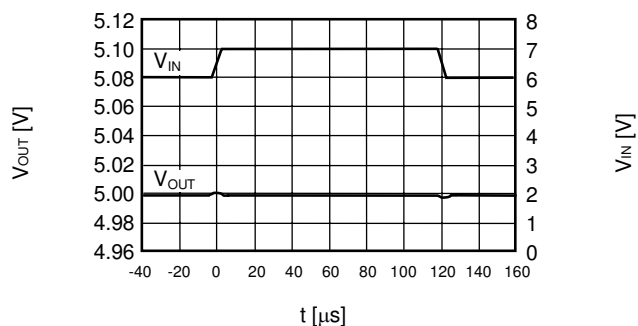
S-1112B30 ($T_a = 25^\circ\text{C}$)

$I_{OUT} = 30\text{ mA}$, $t_r = t_f = 5.0\ \mu\text{s}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 0\ \mu\text{F}$



S-1112B50 ($T_a = 25^\circ\text{C}$)

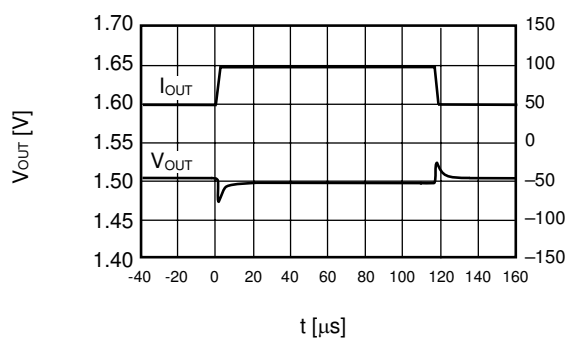
$I_{OUT} = 30\text{ mA}$, $t_r = t_f = 5.0\ \mu\text{s}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 0\ \mu\text{F}$



(2) Load transient response characteristics

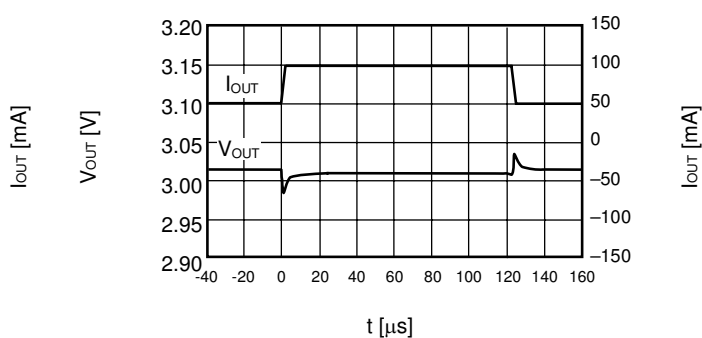
S-1112B15 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 2.5\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 1.0\ \mu\text{F}$, $I_{OUT} = 50 \leftrightarrow 100\text{ mA}$



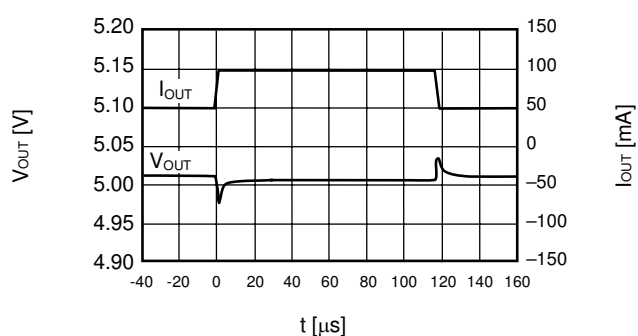
S-1112B30 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 4.0\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 1.0\ \mu\text{F}$, $I_{OUT} = 50 \leftrightarrow 100\text{ mA}$



S-1112B50 ($T_a = 25^\circ\text{C}$)

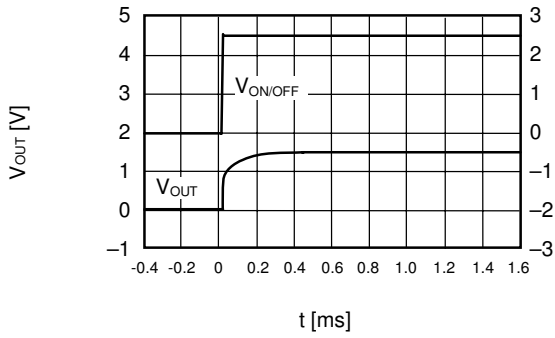
$V_{IN} = 6.0\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 1.0\ \mu\text{F}$, $I_{OUT} = 50 \leftrightarrow 100\text{ mA}$



(3) Shutdown pin transient response characteristics

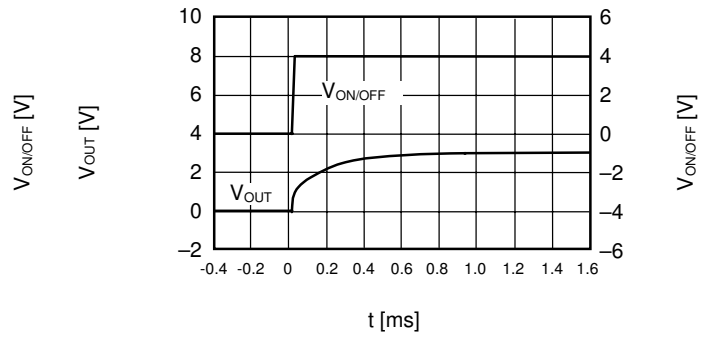
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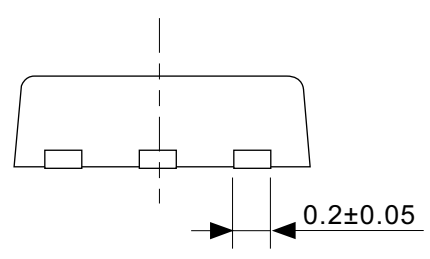
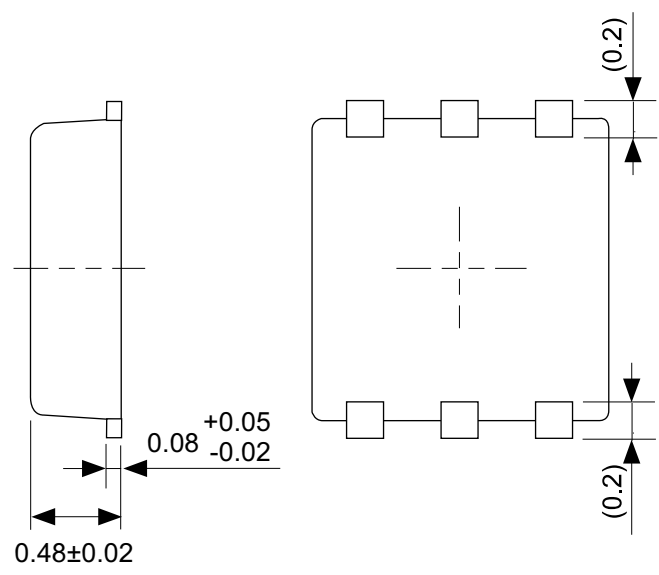
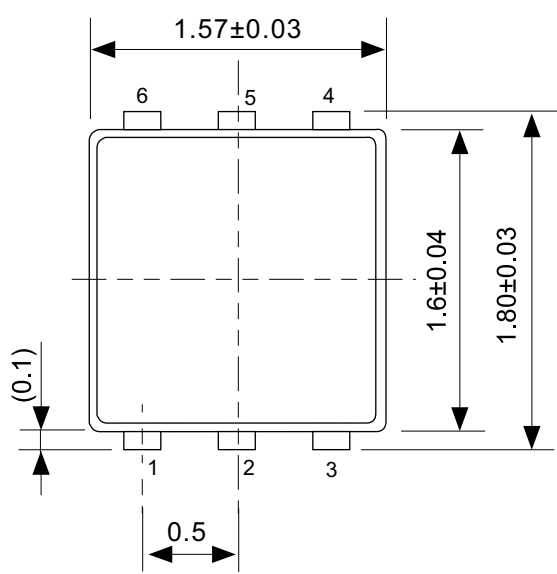
$V_{IN} = 2.5\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 1.0\ \mu\text{F}$, $I_{OUT} = 100\text{ mA}$



S-1112B30 ($T_a = 25^\circ\text{C}$)

$V_{IN} = 4.0\text{ V}$, $C_{OUT} = 0.47\ \mu\text{F}$, $C_{IN} = 1.0\ \mu\text{F}$, $I_{OUT} = 100\text{ mA}$

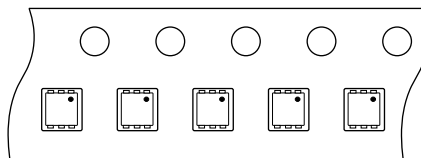
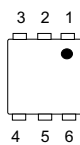
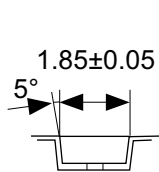
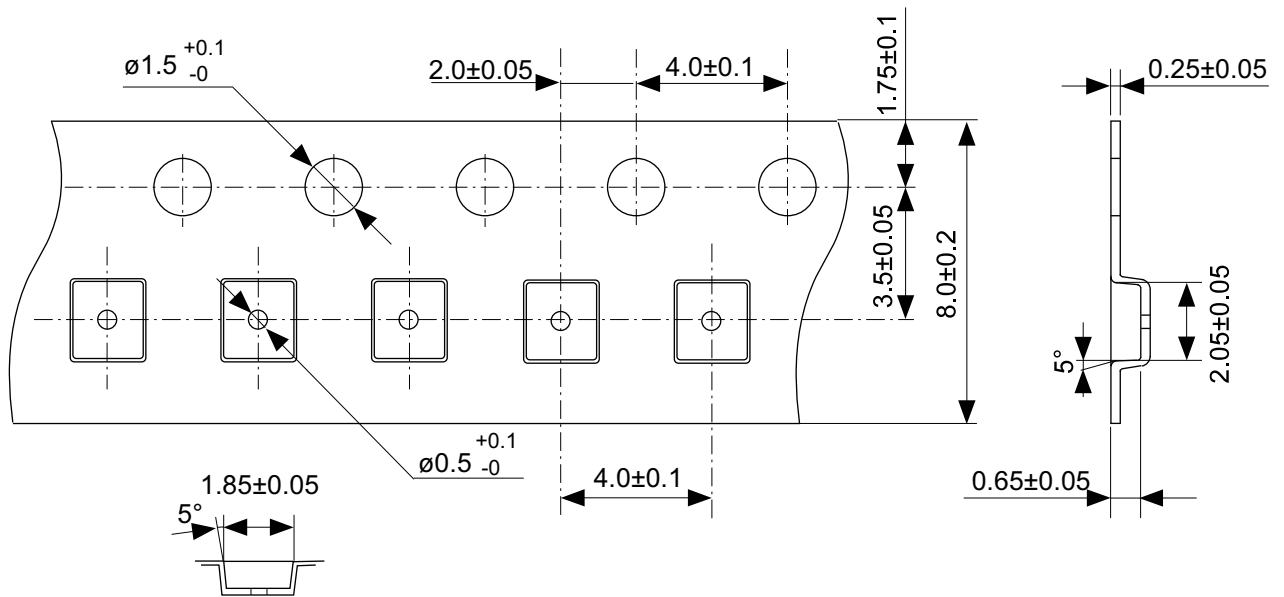




No. PI006-A-P-SD-2.0

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UNIT	mm

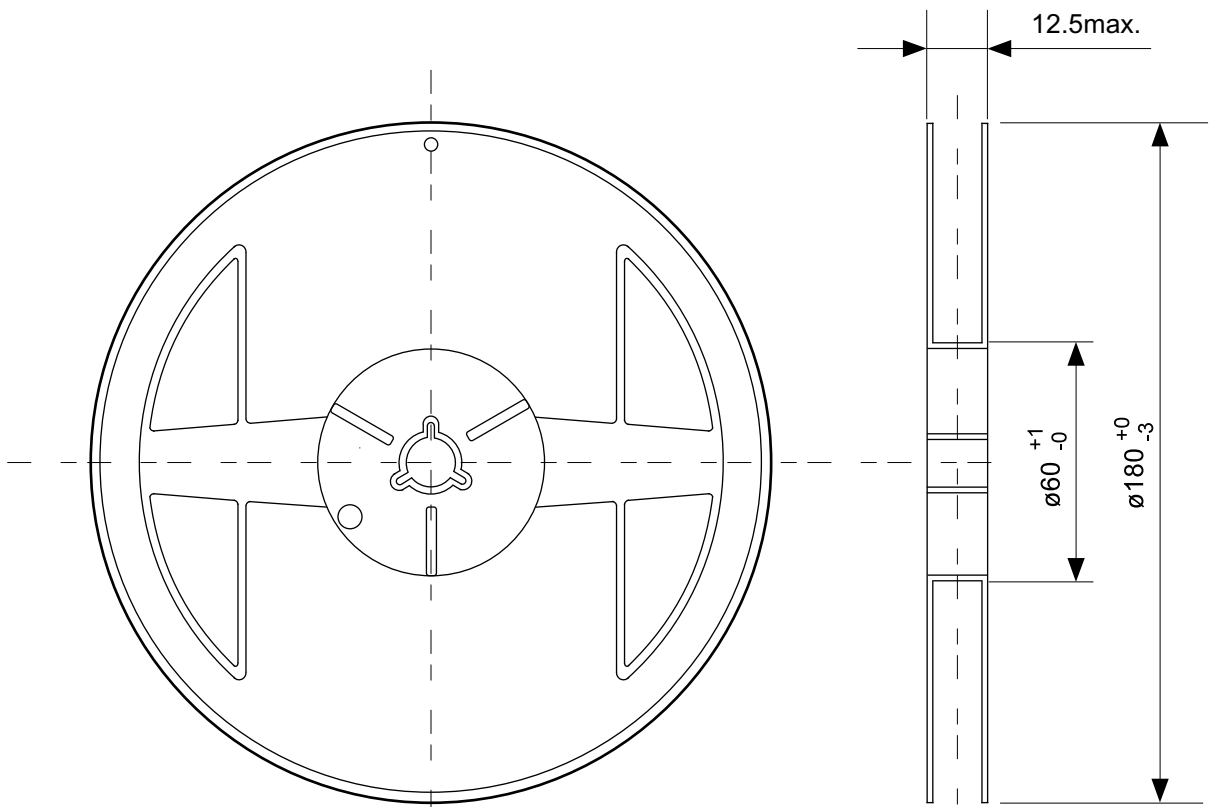
Seiko Instruments Inc.



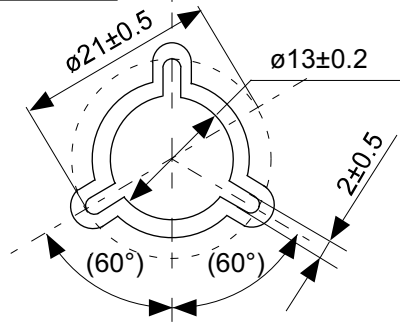
→
Feed direction

No. PI006-A-C-SD-1.0

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No.	PI006-A-C-SD-1.0
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UNIT	mm
Seiko Instruments Inc.	

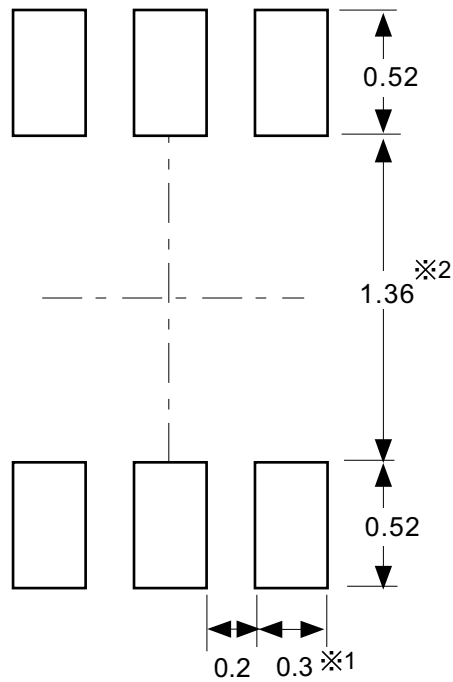


Enlarged drawing in the central part



No. PI006-A-R-SD-1.0

TITLE	SNT-6A(H)-A-Reel		
No.	PI006-A-R-SD-1.0		
SCALE		QTY.	5,000
UNIT	mm		
Seiko Instruments Inc.			



※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.).

※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意
1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm以下にしてください。
 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。

※1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).

※2. Do not widen the land pattern to the center of the package (1.30 mm to 1.40 mm).

- Caution**
1. Do not do silkscreen printing and solder printing under the mold resin of the package.
 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 3. Match the mask aperture size and aperture position with the land pattern.
 4. Refer to "SNT Package User's Guide" for details.

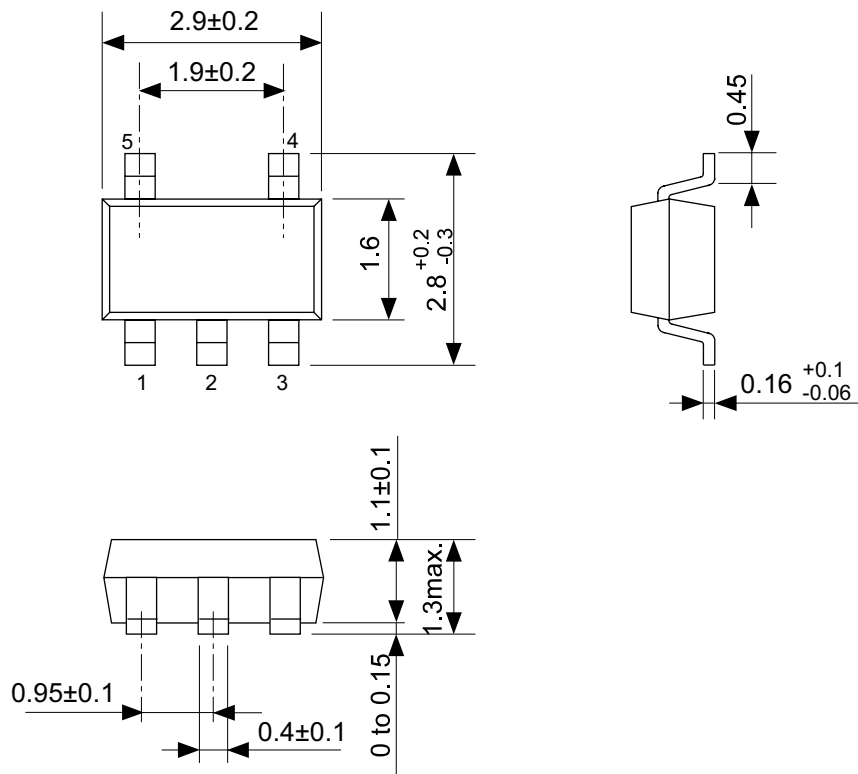
※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。

※2. 请勿向封装中间扩展焊盘模式 (1.30 mm ~ 1.40 mm)。

- 注意
1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在0.03 mm以下。
 3. 掩膜的开口尺寸和开口位置请与焊盘模式对齐。
 4. 详细内容请参阅 "SNT封装的应用指南"。

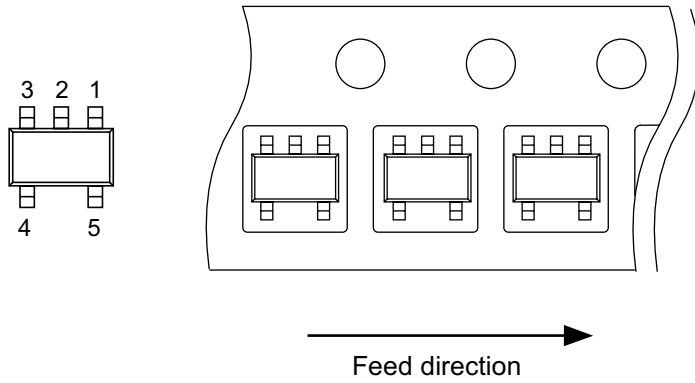
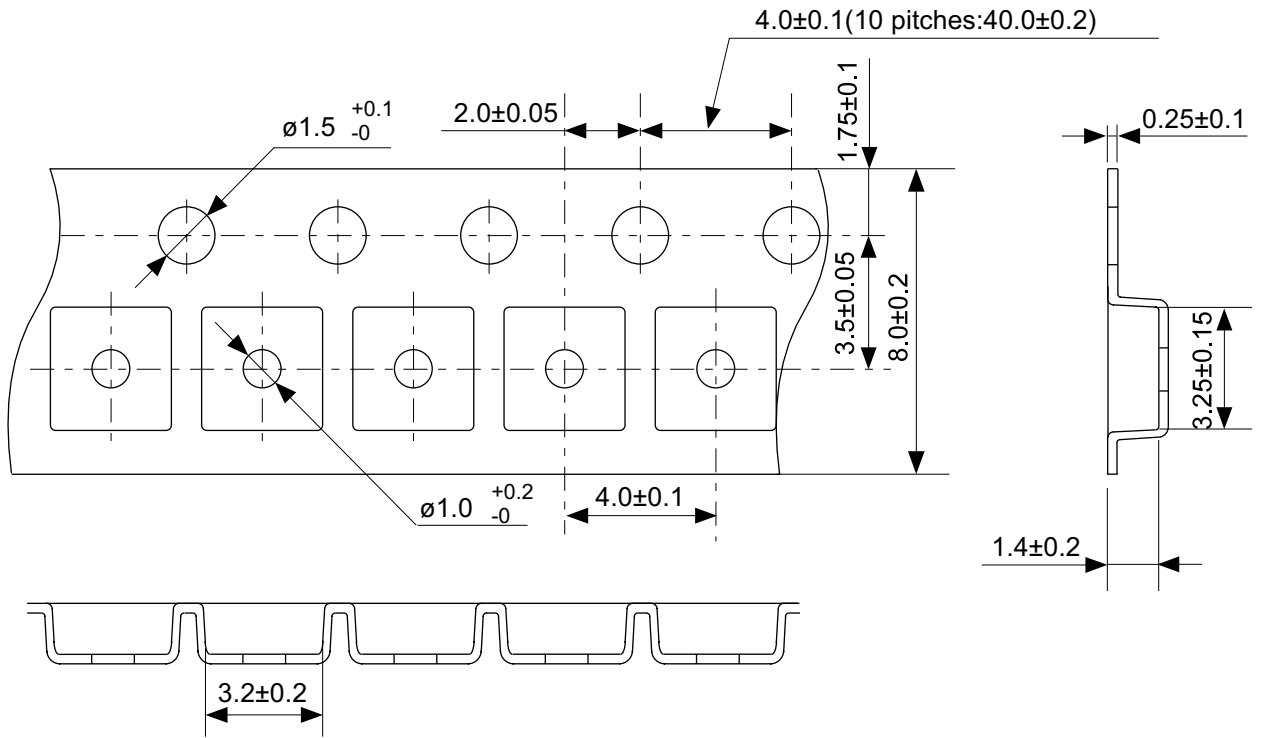
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Seiko Instruments Inc.	



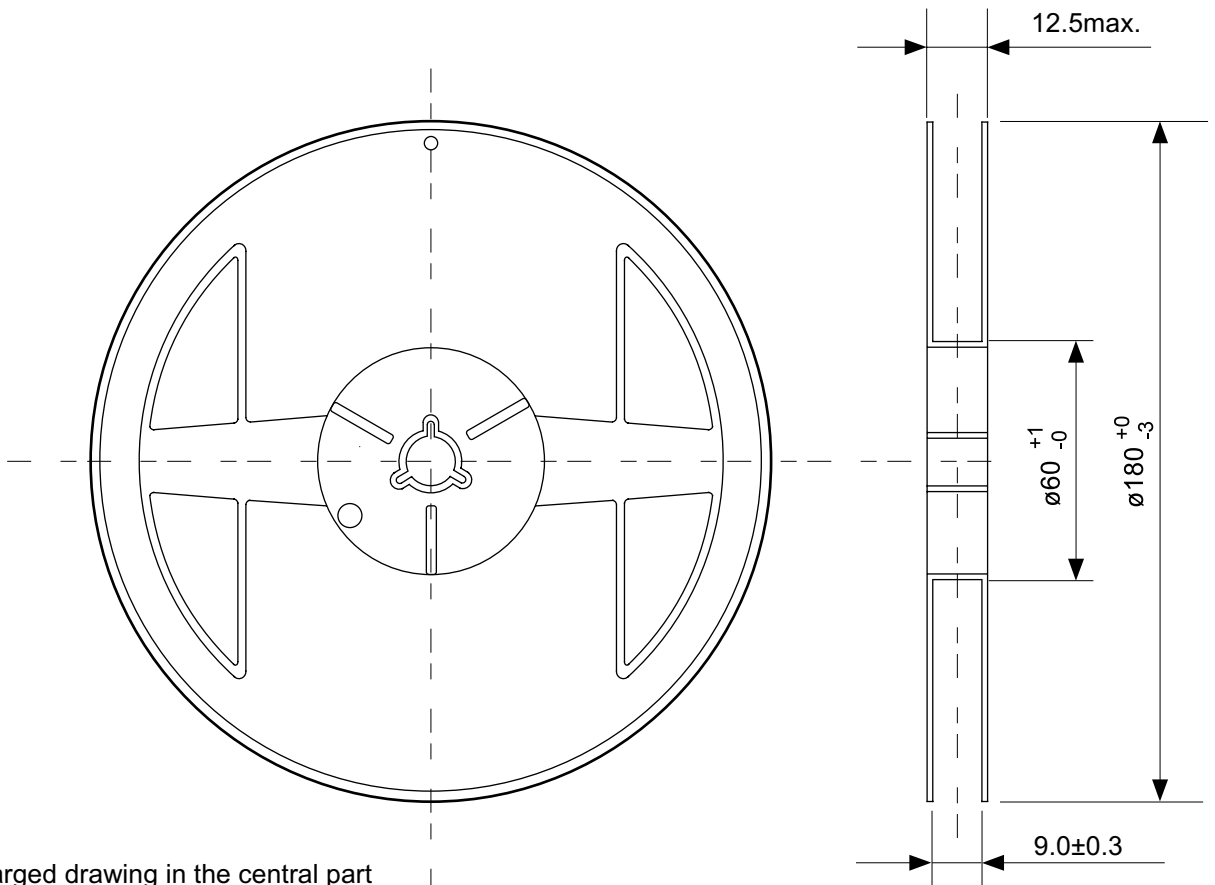
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Seiko Instruments Inc.	

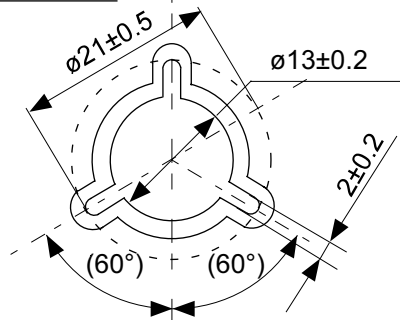


No. MP005-A-C-SD-2.1

TITLE	SOT235-A-Carrier Tape
No.	MP005-A-C-SD-2.1
SCALE	
UNIT	mm
Seiko Instruments Inc.	



Enlarged drawing in the central part



No. MP005-A-R-SD-1.1

TITLE	SOT235-A-Reel		
No.	MP005-A-R-SD-1.1		
SCALE		QTY.	3,000
UNIT	mm		

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